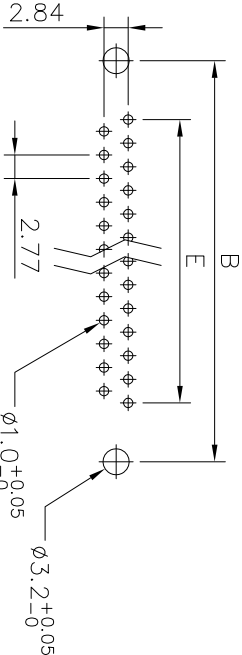
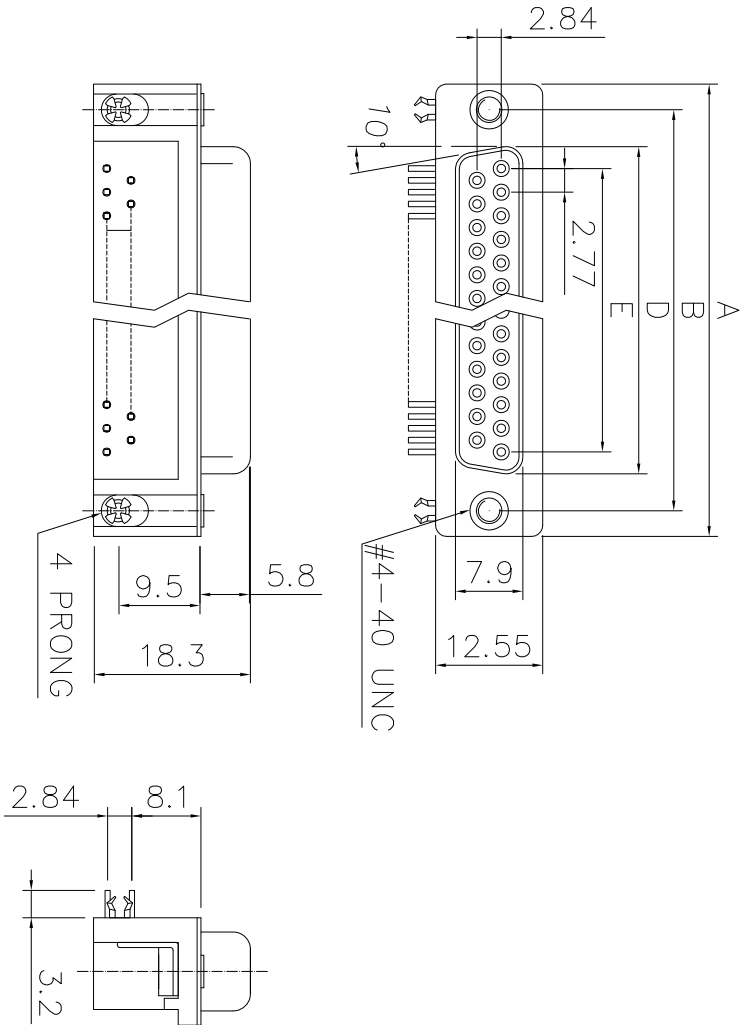


Customer drawing



Positions	A	B	D	E
9	30.81	24.99	16.33	11.08
15	39.20	33.30	24.70	19.39
25	53.05	47.04	38.40	33.24
37	69.40	63.50	54.80	49.86

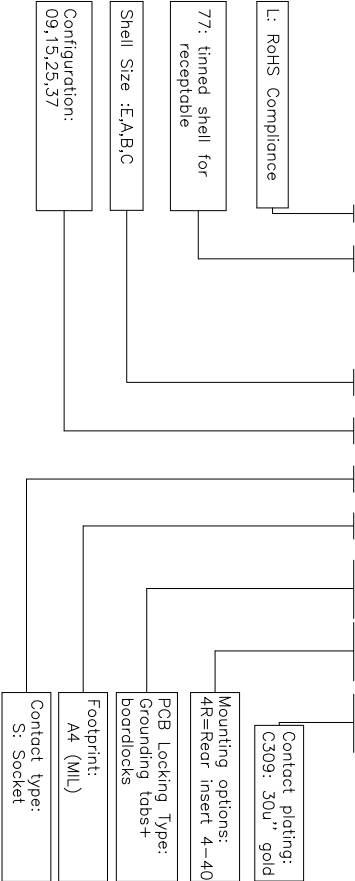
REVISIONS			
SYM	ECN	DESCRIPTION	DATE
1	HK--	First Release Drawing	7/12/13
			APPROVED
			IP

D-SUB TECHNICAL DATA

- SHELL : Steel, 100u" Tin Over 50u" min nickel over 50u" min Copper
- BODY : Glass-Filled Thermoplastic PBT, UL94V-0
- CONTACTS : Copper alloy
- 30u" gold over 50u" nickel on mating area
- 100u" tin over 50u" nickel on solder area
- BOARDLOCK: Brass, Tin Plated.
- RIVET: Brass, Nickel Plated.
- ELECTRICAL : Voltage rating 250 V Rms to 60 Hz
- Current Rating :3 AMP
- Withstanding Voltage >1000 V Rms to 60 Hz for one minute
- Insulation resistance >1000 M Ohms
- Contact resistance 20 mOhms max at 1 AMP DC.
- MARKING : Amphenol...(Series No.)
- Commercial reference
- Manufacturing date

PRODUCT CODE

L 77 SD XXX S A4 CH 4R C309



UNLESS OTHERWISE SPECIFIED			
TOLERANCES	U.S.	METRIC	
.X +/-.XX +/-.XXX +/-.FRACTIONS +/-.ANGLES +/-.5"	0.50 0.30 0.20	7/12/13	
FOR MATERIALS AND FINISHES SEE NOTES REMOVE SHARP EDGES			
DIMENSIONS			
U-S THAS			
THAS			
MM			
ANGLE OF PROJECTION			
DRAWING FILE :			
TITLE			
D-sub, R/A			
Amphenol			
Amphenol East Asia Limited			
SIZE DRAWING NO			
A4			
C L77SDXXXSA4CH4RC309			
SCALE			
NONE			
SHEET 1 OF 1			